

# **Multilayer Ceramic Chip Capacitor**

Part Number: 2211YA250332KJTSYX

**Description:** 2211 250Vac (Y2), 305Vac (X1), 50/60Hz / 1000Vdc 3.3nF ±10% X7R (2R1)

IEC/EN60384-14:2013+A1 Approval

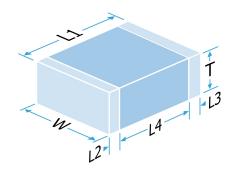
Specifications: UL60384-14, CAN/CSA E60384-14:14

TÜV R60156291 / ID11111239246 Certification:

UL/cUL E228790-20210208

IEC/EN 60384-14:2013+A1 Class Y2 / X1 Classification:

UL/cUL FOWX2, FOWX8



Component Marking and Certification Bodies:



Material Group I: CTI >= 600

### Mechanical Specification

Size Code 2211

 $5.7 \pm 0.40 \ (0.225 \pm 0.016)$ Length (L1) in mm (") Width (W) in mm (")  $2.79 \pm 0.30 (0.11 \pm 0.012)$ 

Thickness (T) in mm (") 2.54 Max (0.1 Max)

0.50 (0.020) Minimum Termination Band (L2,L3) in mm (") Maximum Termination Band (L2,L3) in mm (") 0.80 (0.030)

Minimum Band Gap (L4) in mm (") (per IEC/EN 60384-14) 4.0 (0.158)

FlexiCap™ Polymer termination, Nickel barrier, Sn Plated Solder **Termination Material** 

Solderability IEC-60068-2-58 7" Reel Horizontal Orientation, 750 per reel Packaging

## **General Electrical Specification**

Rated Voltage

**Humidity Grade** 

Maximum DC Working Voltage Nominal Capacitance Value Capacitance Tolerance

Tangent of Loss Angle (Tan  $\delta$ )

Capacitance and Tan δ Test Conditions

Voltage Proof

(50mA max charging current for DC tests. 50% Max, RH)

Min Insulation Resistance (IR) Dielectric Classification Rated Temperature Range

Maximum Capacitance Change over Temperature Range

Climatic Category (IEC) Ageing Characteristic

Class Y2 (250Vac), Class X1 (305Vac), 50/60Hz, 5kV impulse

Grade IIIB (IEC/EN60384-14:2013 Annex I)

1000Vdc to Annex H / (2500Vdc outside scope of any specification)

3.3nF +10% ≤0.025

1.0Vrms @ 1kHz

(RoHS compliant)

100% test: 4000Vdc 1s min / 5s max

AQL test: 4000Vdc / 3000Vac 60s min / 5kV 1.2x50µs impulse

100.00GOhm @ 100Vdc

X7R (2R1) -55°C / +125°C

No DC Voltage +15% Rated DC Voltage -

55/125/56

<2% per decade (nominal capacitance is 1000 hour value)

This datasheet is for a standard item and is confirmed valid on the date generated, the latest published data

#### **Knowles Precision Devices - Sales**

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omissions excepted.

Date: Monday, February 24, 2025



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#### **Environmental**

RoHS Compliant to 2011/65/EC as amended by 2015/863/EU

Compliant

**REACH Compliant** 

241 compliant

California Proposition 65

No exposure risk

### **Board Layout**

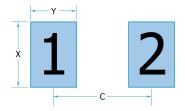
Knowles' conventional 2-terminal chip capacitors can generally be mounted using pad designs in accordance with international specification IPC-7351, Generic Requirements for Surface Mount Design and Land Pattern Standards, but there are some other factors that have been shown to reduce mechanical stress, such as reducing the pad width to less than the chip width. In addition, the position of the chip on the board should be considered.

Some high voltage parts may require modifications to the board layout and/or the addition of a conformal coating to prevent flashover, especially under high humidity conditions. Board cleanliness and environmental conditions can also impact this. Refer to application note AN0043 for further information.

Dimensions given are for guidance. It is ultimately the customers responsibility to confirm that the circuit layout is in accordance with their own product requirements.

#### IPC-7351 pad design

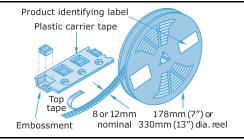
	2211	
С	6.00mm	0.236"
Υ	1.50mm	0.059"
X	3.10mm	0.122"



### **Packaging**

Tape packaging information for tape-and-reel parts:

Tape and reel packing of surface mounting chip capacitors for automatic placement are in accordance with IEC60286-3.



#### Soldering

Reflow solder in accordance with IPC-A-610. Recommended reflow profile as laid down in IPC/JEDEC J-STD-020.

Wave soldering is also possible, but care must be taken for case sizes 1210 and larger and component thickness >1.0mm. Trials are encouraged.

Hand soldering is not recommended and can lead to component damage through thermal shock.

DLI

**Temperature** Preheat Time

Application notes with mounting and handling guidance are available on request.

# **Knowles Precision Devices - Sales**

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Novacap

Syfer

Voltronics

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